

晶片、AI與系統創新之國際研討會，串聯國內外產學研交流平台

工業技術研究院年度重點活動「2026國際超大型積體電路設計、系統暨應用研討會(VLSI TSA)」，集結近 60 位全球半導體產業領導廠商與頂尖學者，帶您掌握最新技術趨勢與市場動向。

席位有限，誠摯邀請您立即報名參與。

研討會焦點內容

- 精選全球頂尖論文逾百篇
- 2場聯合主題議程
 - 6G/High-frequency Circuit Design Techniques and Advanced Devices
 - Design for Logic, Memory, and AI in Advanced Technology
- 7場特別主題議程
 - Wide Bandgap Devices
 - Ferroelectric Devices and Applications
 - Emerging Logic and Memory Technologies
 - Thermal Management and Materials for Advanced CMOS and Packaging
 - AI Processor Design
 - AI-assisted Chip Design
 - Intelligent Sensor Interface Circuits for Emerging Applications
- 2場國內IC設計廠商領先技術之研究成果(Industrial Sessions)
 - Device/Interconnect Reliability
 - Edge AI Accelerators
- 3場深度短期課程
 - Digital Twin for Semiconductor Manufacturing
 - Silicon Photonics: From Programmable Devices to AI Systems
 - Circuit Design in AI Era

大師專題演講

- **Plenary Session 1**
 - Bendik Kleveland, Cerebras Systems Inc.
 - Ingrid Verbauwhede, KU Leuven
- **Plenary Session 2**
 - Alessandro Calderoni, Micron Technology, Inc.
 - Minoru Fujishima, Hiroshima University
- **Plenary Session 3**
 - Shu-Jen Han, SEEQC Inc.
 - Youn-Long Lin, National Tsing Hua University
 - Shih-Ann Chen, National Yang Ming Chiao Tung University
Taipei Veterans General Hospital



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Micron Technology, Inc.



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更多資訊



立即註冊